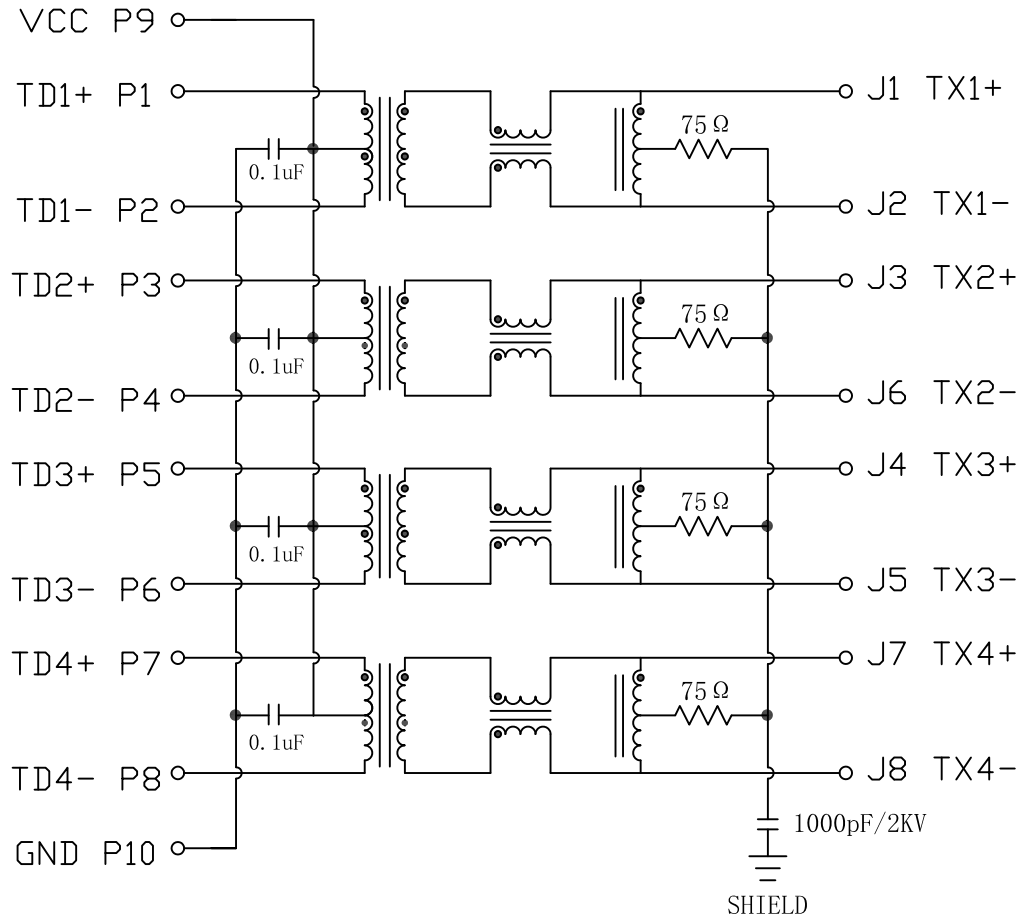


Schematic:

REV.	ECN NO.	DESCRIPTION	DATE	APPD
A	REL		2007-06-19	

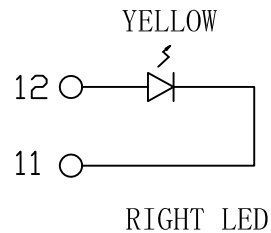
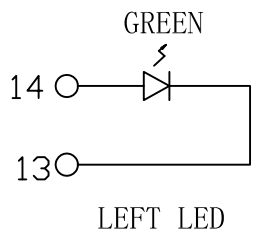
PCB CONNECTIONS



RJ45 CONNECTOR

Electrical Specifications @25°C

- Turns Ratio:
PRI:SEC = 1CT:1 ±2%
- 0CL: 350uH MIN
@100KHz, 100mV, 8mADC
- Insertion Loss:
1~100MHz:-1.0dB MAX
- Return Loss(dB MIN @100Ω):
1~30MHz:-18 30~60MHz:-16
60~80MHz:-12 80~100MHz:-10
- Crosstalk:
1~100MHz:-30dB MIN
- Common Mode Rejection:
1~100MHz: -30dB MIN
- Isolation: 1500Vrms MIN
- Operating Temperature: 0°C~+70°C.

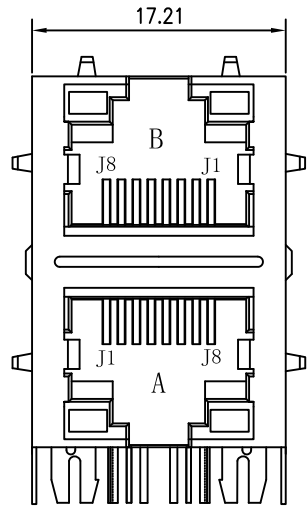


Emitting Color	λ p(nm)	VF@IF=20mA	IR @VR=5V
GREEN	565	1.8~2.4V	10 μ A max
YELLOW	585	1.8~2.4V	10 μ A max

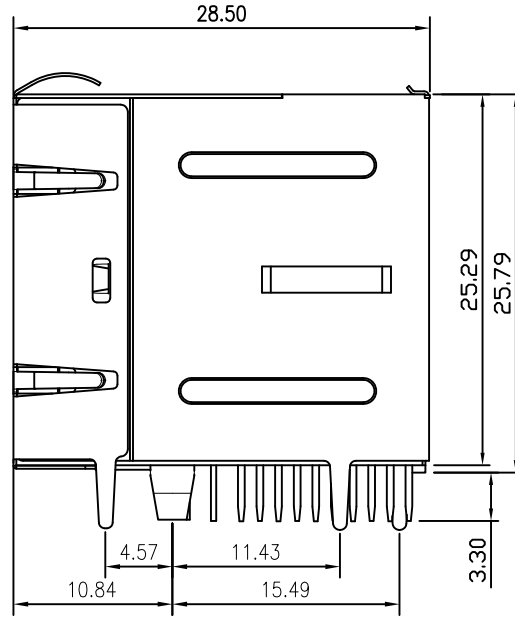
X:X ±0.30	APPD:	LINK-PP INT'L TECHNOLOGY CO., LIMITED	
X:XX ±0.25	CHKD:	TITLE: 2*1 RJ45 Connector with 1000 Base-T Integrated Magnetics	
X:XXX ±0.05	DR: TOM	PART NO.: LPJG17512AHNL	
ANGLES ±1°	UNIT: mm		
	SCALE: 2/1	SHEET: 1/2	REV: A DWG NO.: LP07061923

Mechanical:

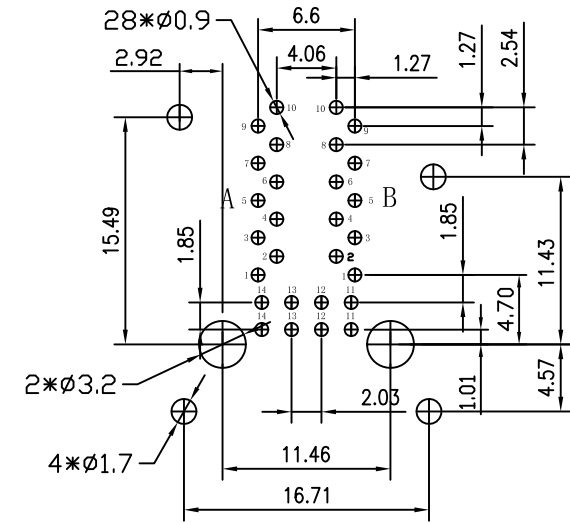
REV.	ECN NO.	DESCRIPTION	DATE	APPD
A	REL		2007-06-19	



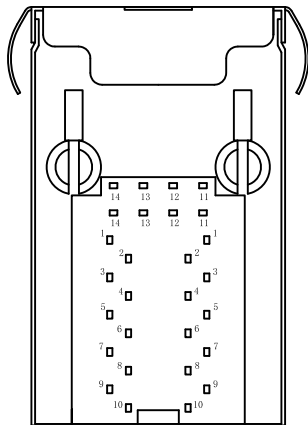
Front Side View



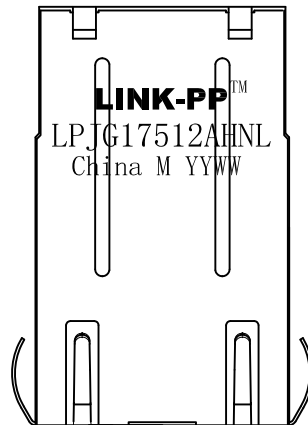
Left Side View



Suggested PCB Layout (Top View)



Bottom Side View



Top Side View

NOTES:

1. Meets IEEE 802.3 specification
2. Connector Materials:
 Housing Material: Thermoplastic PBT+30%G. F UL94V-0
 Contact Material: Phosphor Bronze C5210R-EH Thickness=0.35mm
 Pins: Brass C2680R-H Thickness=0.35mm
 Shield: Copper alloy Brass H65Y Thickness=0.20mm
 Shield plating: Nickel
 Contact plating: Gold 6 micro-inches min. In contact area.
3. Wave solder tip temperature: 265°C Max, 5 Sec Max.
4. UL Certification: File Number E484635.



X:X ±0.30	APPD:	LINK-PP INT'L TECHNOLOGY CO., LIMITED
X:XX ±0.25	CHKD:	
X:XXX ±0.05	DR: TOM	TITLE: 2*1 RJ45 Connector with 1000 Base-T Integrated Magnetics
ANGLES ±1°	UNIT: mm	PART NO.: LPJG17512AHNL
	SCALE: 2/1	SHEET: 2/2
	REV: A	DWG NO.: LP07061923